# **Tyrone Camarero Specifications**

# **Tyrone**

# Camarero-SSA200A2W-18

# **Key Feature**

Virtualization, Software-defined Storage, Al Inference and Machine Learning, Cloud Computing, Enterprise Server

- 4th Generation AMD EPYC<sup>™</sup> 9004 Series Processor, Single Socket SP5, Up to 128C/256T
- · System on Chip
- "24 DIMM slots with 2 DIMM per channel (up to 6TB DDR5-4000MHz(1R)/3600MHz(2R)) OR
- 12 DIMM slots with 1 DIMM per channel (up to 3TB DDR5-4800MHz)"
- 1 PCle 5.0 x16, FH, 6.6"L, 2 PCle 5.0 x16 FH, 10.5"L, Flexible networking options with 1 AIOM networking slot (OCP NIC 3.0 compatible)
- 8 Hot-swap 2.5" NVMe/SAS/SATA (Option for up to 12 drives), (Optional parts required for NVMe/SAS/SATA configurations)
- 800/1200W Redundant Power Supplies (Titanium Level) (\*Full redundancy based on configuration and application load)
- 2 On-board NVMe M.2 slots; 1x PCle 3.0 x4, 1x PCle 3.0 x2; 80mm/110mm (Boot)





8x 4cm heavy duty fans with optimal fan

"Dimension: Height: 1.7"" (43mm),

Width: 17.2"" (437mm), Depth: 29.4""

#### Processor/Cache

Processor 4th Generation AMD EPYC™ 9004 Series

Processor, Single Socket SP5, Up to

128C/256T

#### System Memory

"24 DIMM slots with 2 DIMM per channel

Memory (up to 6T)

Capacity DDR5-4000MHz(1R)/3600MHz(2R)) OR

12 DIMM slots with 1 DIMM per channel (up

to 3TB DDR5-4800MHz)"

#### Chipset

Chipset System on Chip

#### **Expansion Slot**

**PCI-Express** 1 PCle 5.0 x16, FH, 6.6"L, 2 PCle 5.0 x16 FH,

10.5"L, Flexible networking options with 1

AIOM networking slot (OCP NIC 3.0

compatible)

# Integrated Onboard:

IPMI Support for Intelligent Platform Management

Interface v.2.0, IPMI 2.0 with virtual media over

LAN and KVM-over-LAN support

LAN 1 Dedicated IPMI LAN port

### Add-on Options

Raid Card Optional
Optical None

Drive

Front Panel	
LED	HDD activity, LAN1 activity, Power status, System information
Buttons	Power On/Off, UID button
Drive bays	
HDD Bays	8x 2.5" hot-swap NVMe/SATA/SAS drive bays (Up to 12x 2.5" hot-swap NVMe/SATA/SAS support with additional parts) M.2: 2x NVMe (1x PCle 3.0x4, 1x PCle 3.0x2, Boot drive only)
Power Supply	
Power Supply	1200W Redundant Titanium Level power supplies
Cooling System	

speed control

1U Rackmount

(747mm)"

Email: Info@tyronesystems.com

For more/current product information, Visit

www.tyronesystems.com

**Fans** 

Form Factor

Form Factor

**Dimensions** 

**Dimensions** 

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